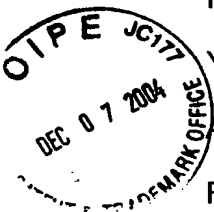


**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**



In re Patent Application of

Yosihisa SATOH et al.

Application No.: 09/720,676

Filed: December 29, 2000

For: SYNTHETIC RESIN MOLDING,  
MOLD APPARATUS FOR AND  
METHOD OF ADJUSTING A  
TEMPERTURE OF THE MOLD

) **MAIL STOP AMENDMENT**

)  
) Group Art Unit: 1732

)  
) Examiner: Edmund H. Lee

)  
) Confirmation No.: 4205

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated September 9, 2004, please amend the  
above-identified patent application as follows:

12/08/2004 HDEMESS1 00000106 09720676

01 FC:1201

176.00 OP